Package

Pin Name
1: Drain

2: Source 3: Gate

TSSSMini3-F1

Marking Symbol: 4S

Code

stage inved type

2SK3866

Silicon N-channel junction FET

For impedance conversion in low frequency For electret capacitor microphone

Features

- Low noise voltage NV
- High voltage gain GV
- Thin package: TSSSMini3-F1 (1.2 mm \times 1.2 mm \times 0.33 mm)

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Drain-source voltage (Gate open)	V _{DSO}	20	V
Drain-gate voltage (Souece open)	V _{DGO}	20	V
Drain-source current (Gate open)	I _{DSO}	2	mA
Drain-gate current (Souece open)	I _{DGO}	2	mA
Power dissipation	PD	100	mW
Channel temperature	T _{ch}	125	°C
Storage temperature	T _{stg}	-55 to +125	°C

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain current *1	ID	$V_{\rm DD} = 2.0 \text{ V}, \text{ R}_{\rm d} = 2.2 \text{ k}\Omega \pm 1\%$	100		330	μΑ
Drain-source current *2	I _{DSS}	$V_{DD} = 2.0 \text{ V}, \text{ R}_{d} = 2.2 \text{ k}\Omega \pm 1\%, \text{ V}_{GS} = 0$	107		310	μΑ
Mutual conductance	g _m	$V_{DS} = 2.0 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$	660	1 500		μS
Noise voltage *3	NV	$V_{DD} = 2.0 \text{ V}, \text{R}_{d} = 2.2 \text{ k}\Omega \pm 1\%$ $C_{O} = 5 \text{ pF}, \text{A-curve}$			8	μV
Voltage gain	G _{V1}	$V_{DD} = 2.0 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_0 = 5 \text{ pF}, e_G = 10 \text{ mV}, f = 1 \text{ kHz}$	-5.0	-1.0		
	G _{V2}	$V_{DD} = 12 \text{ V}, \text{R}_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_0 = 5 \text{ pF}, \text{ e}_G = 10 \text{ mV}, \text{ f} = 1 \text{ kHz}$	-3.0	3.0		
	G _{V3}	$V_{DD} = 1.5 \text{ V}, \text{ R}_{d} = 2.2 \text{ k}\Omega \pm 1\%$ $C_{O} = 5 \text{ pF}, \text{ e}_{G} = 10 \text{ mV}, \text{ f} = 1 \text{ kHz}$	-7.0	-1.5		dB
Voltage gain difference	$\Delta G_V . f *4$	$\begin{split} V_{DD} &= 2.0 \text{ V}, \text{ R}_{d} = 2.2 \text{ k}\Omega \pm 1\% \\ C_{O} &= 5 \text{ pF}, \text{ e}_{G} = 10 \text{ mV} \\ \text{f} &= 1 \text{ kHz to } 70 \text{ Hz} \end{split}$		0.0	1.7	
	$ G_{V1} - G_{V3} $			0.5	1.0	dB

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

 A protection diode is built-in between gate and source of transistor. However if forward current flows between gate and source transistor might be damaged. So please be careful not insert reverse.

3. *1: $I_{\rm D}$ is assured for $I_{\rm DSS}$.

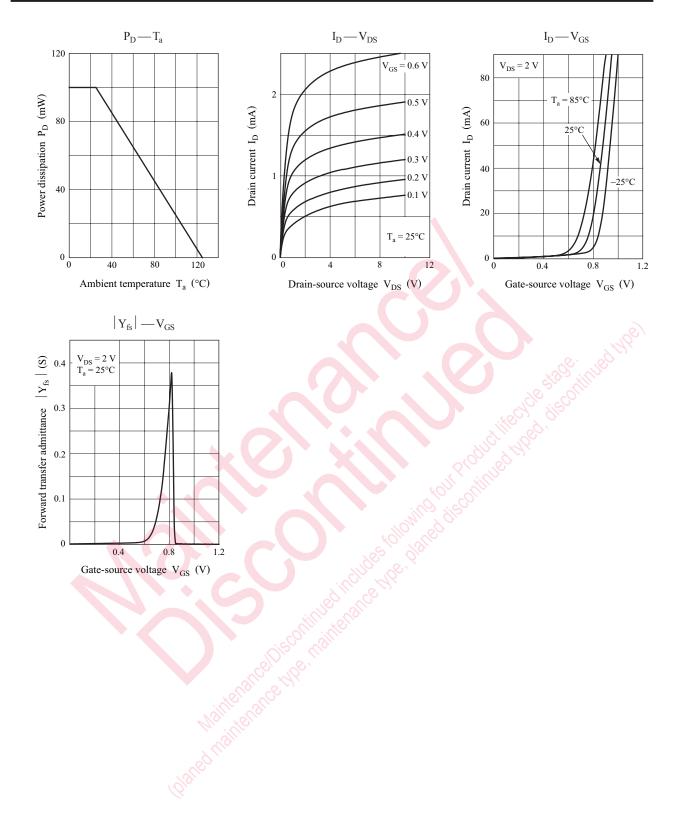
*2: Rank classification							
	Rank	S	Т				
	$I_D(\mu A)$	100 to 220	180 to 330				
	$I_{DSS}(\mu A)$	107 to 210	190 to 310				

*3: NV is assured for design.

*4: $\Delta |G_V \cdot f|$ is assured for AQL 0.065. (The measurement method is used by source-grounded circuit.)

2SK3866

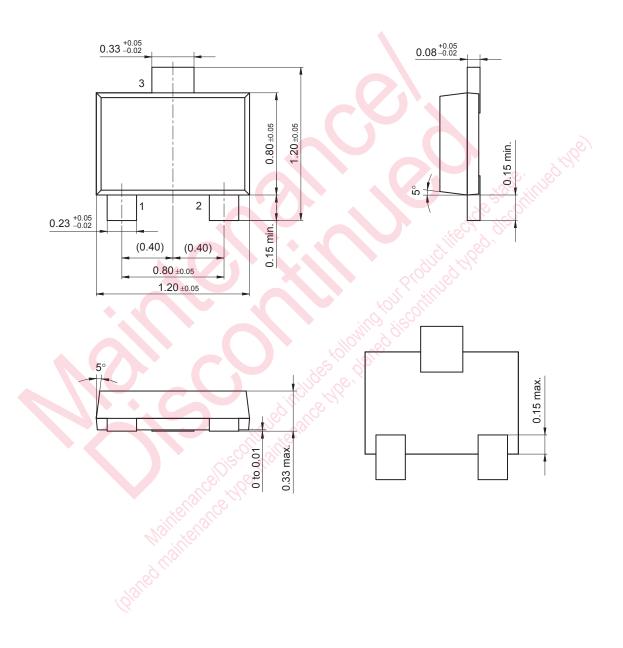
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TSSSMini3-F1

Unit: mm



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